ASSOCIATION CONNECTION ELECTRONICS INDUSTRIE	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				nder both This do level pa	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					ials and Mfg Information				
upplier Inforn	nation														
Company name*			Company unique ID			Uni	Unique ID Authority					Response Date*			
nsemi											2025-06-04				
Contact Name		Title - Contact			Pho	Phone - Contact*				Email - Contact*					
Product-Env-Stew	ards		Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com				
uthorized Repres	entative*	Title - Representative			Pho	Phone - Representative*				Email - Representative*					
Product-Env-Stew	ards	Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com					
Request	Requester Item Number Mfr Item		n Number Mfr Item Name			Ef	fective Date	Date Version Manufacturing Site		V	Weight*	UOM	Unit Type		
		NCV8705ML33TCG 500 mA Ultra-Lo SLP		ow Noise LDO, Vout=3	.3V, 20	. 2025-06-04 MY1		2	23.83	mg	Each				
Ianufacturing	Process Information	n													
Terminal Plating / Grid Array Material Terminal Plating / Grid Array Material			erminal Base Alloy J-STD-020 MSL I		J-STD-020 MSL Rating	5	Peak Process Body Temperature Max Time at P		e Max Time at Peak	Temperat	ure Numl	ber of Reflow Cyc	eles		
Matte Tin (Sn) - annealed		CU Alloy 1		1		260	C 30		30	secon	ds 3				
omments															
vel 1 - maximum	time at peak temperature	during sol	dering is 10-3	0 seconds											
or more informati	ion regarding material co	mposition 1	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and corrections that such information is true and corrections that it gathered the information is true and corrections are at least as completed and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier has not or written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier pr											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.45	mg	Supplier	Silicon (Si)	7440-21-3		0.45	mg
Die Attach	0.15	mg	Supplier	Silver (Ag)	7440-22-4		0.1275	mg
			Supplier	Acrylic resins	Proprietary Data		0.0225	mg
Lead Frame	9.89	mg	Supplier	Tin (Sn)	7440-31-5		0.0247	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0218	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0247	mg
			Supplier	Copper (Cu)	7440-50-8		9.8188	mg
Lead Frame plating	0.04	mg	Supplier	Silver (Ag)	7440-22-4		0.04	mg
Mold Compound-Black	12.2	mg		Epoxy resin	proprietary data		0.61	mg
			Supplier	Phenolic Resin	Proprietary Data		0.2806	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.61	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0488	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.2806	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		10.37	mg
Plating	0.75	mg	Supplier	Tin (Sn)	7440-31-5		0.75	mg
Wire Bond - Au	0.35	mg	Supplier	Gold (Au)	7440-57-5		0.35	mg